

FMI16N50ES

FUJI POWER MOSFET

Super FAP-E^{3S} series

N-CHANNEL SILICON POWER MOSFET

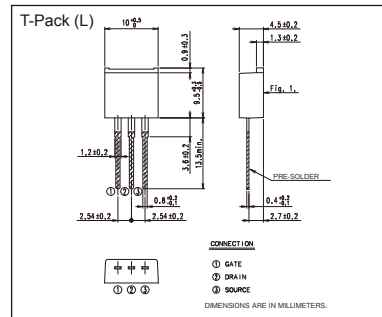
■ Features

Maintains both low power loss and low noise
 Lower $R_{DS(on)}$ characteristic
 More controllable switching dv/dt by gate resistance
 Smaller V_{GS} ringing waveform during switching
 Narrow band of the gate threshold voltage ($4.2 \pm 0.5V$)
 High avalanche durability

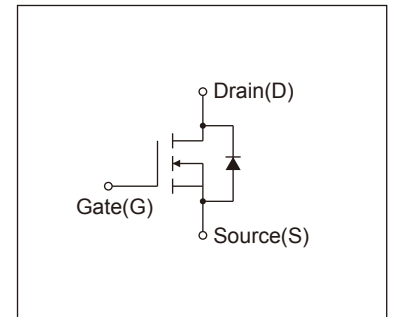
■ Applications

Switching regulators
 UPS (Uninterruptible Power Supply)
 DC-DC converters

■ Outline Drawings [mm]



■ Equivalent circuit schematic



■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings at $T_c=25^\circ\text{C}$ (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	V_{DS}	500	V	
	V_{DSX}	500	V	$V_{GS} = -30V$
Continuous Drain Current	I_D	± 16	A	
Pulsed Drain Current	I_{DP}	± 64	A	
Gate-Source Voltage	V_{GS}	± 30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	I_{AS}	16	A	Note*1
Non-Repetitive Maximum Avalanche Energy	E_{AS}	485	mJ	Note*2
Repetitive Maximum Avalanche Energy	E_{AR}	22.5	mJ	Note*3
Peak Diode Recovery dV/dt	dV/dt	4.8	kV/ μs	Note*4
Peak Diode Recovery $-di/dt$	$-di/dt$	100	A/ μs	Note*5
Maximum Power Dissipation	P_D	2.02	W	$T_a=25^\circ\text{C}$
		225		$T_c=25^\circ\text{C}$
Operating and Storage Temperature range	T_{ch}	150	$^\circ\text{C}$	
	T_{stg}	-55 to + 150	$^\circ\text{C}$	

● Electrical Characteristics at $T_c=25^\circ\text{C}$ (unless otherwise specified)

Description	Symbol	Conditions	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu\text{A}$, $V_{GS}=0V$	500	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D=250\mu\text{A}$, $V_{DS}=V_{GS}$	3.7	4.2	4.7	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=500V$, $V_{GS}=0V$, $T_{ch}=25^\circ\text{C}$	-	-	25	μA
		$V_{DS}=400V$, $V_{GS}=0V$, $T_{ch}=125^\circ\text{C}$	-	-	250	
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 30V$, $V_{DS}=0V$	-	10	100	nA
Drain-Source On-State Resistance	$R_{DS(on)}$	$I_D=8A$, $V_{GS}=10V$	-	0.33	0.38	Ω
Forward Transconductance	g_{fs}	$I_D=8A$, $V_{DS}=25V$	5.5	11	-	S
Input Capacitance	C_{iss}	$V_{DS}=25V$	-	1700	2550	pF
Output Capacitance	C_{oss}	$V_{GS}=0V$	-	210	315	
Reverse Transfer Capacitance	C_{rss}	$f=1\text{MHz}$	-	13	19.5	
Turn-On Time	$t_{d(on)}$	$V_{cc}=300V$	-	37	55.5	ns
	t_r	$V_{GS}=10V$	-	30	45	
Turn-Off Time	$t_{d(off)}$	$I_D=8A$	-	87	130.5	
	t_f	$R_{GS}=18\Omega$	-	17	25.5	nC
Total Gate Charge	Q_G	$V_{cc}=250V$	-	48	72	
Gate-Source Charge	Q_{GS}	$I_D=16A$	-	17	25.5	
Gate-Drain Charge	Q_{GD}	$V_{GS}=10V$	-	18	27	
Gate-Drain Crossover Charge	Q_{SW}		-	7	10.5	
Avalanche Capability	I_{AV}	$L=1.52\text{mH}$, $T_{ch}=25^\circ\text{C}$	16	-	-	A
Diode Forward On-Voltage	V_{SD}	$I_F=16A$, $V_{GS}=0V$, $T_{ch}=25^\circ\text{C}$	-	0.90	1.35	V
Reverse Recovery Time	t_{rr}	$I_F=16A$, $V_{GS}=0V$	-	0.46	-	μs
Reverse Recovery Charge	Q_{rr}	$-di/dt=100A/\mu\text{s}$, $T_{ch}=25^\circ\text{C}$	-	6.0	-	μC

● Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	$R_{th(ch-c)}$	Channel to Case			0.560	$^\circ\text{C/W}$
	$R_{th(ch-a)}$	Channel to Ambient			75.0	$^\circ\text{C/W}$

Note *1 : $T_{ch} \leq 150^\circ\text{C}$.

Note *2 : Stating $T_{ch}=25^\circ\text{C}$, $I_{AS}=7A$, $L=18.1\text{mH}$, $V_{cc}=50V$, $R_G=50\Omega$.

E_{AS} limited by maximum channel temperature and avalanche current.

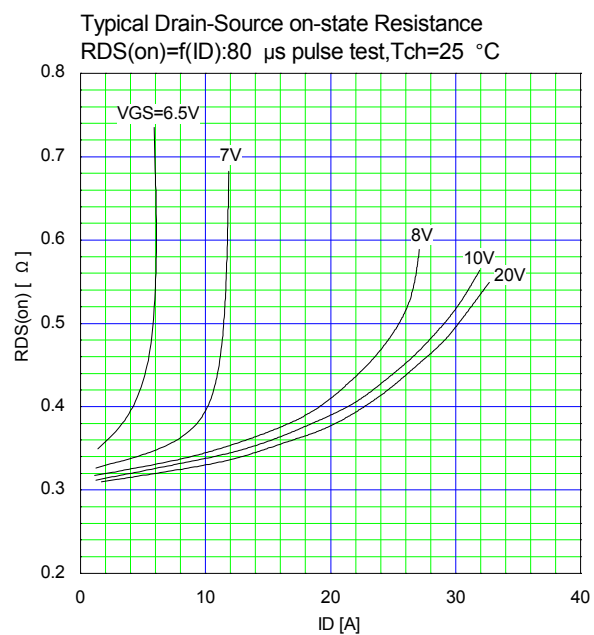
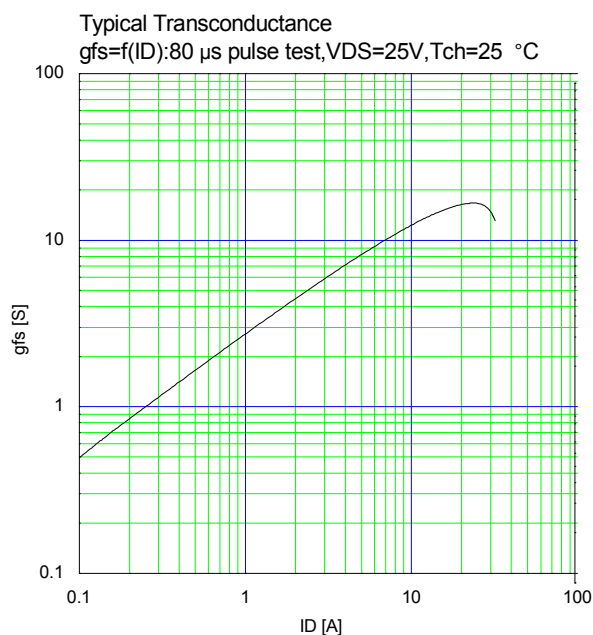
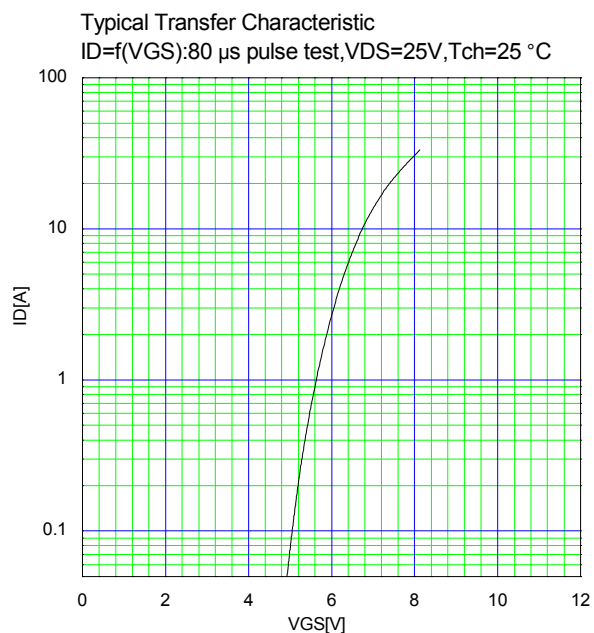
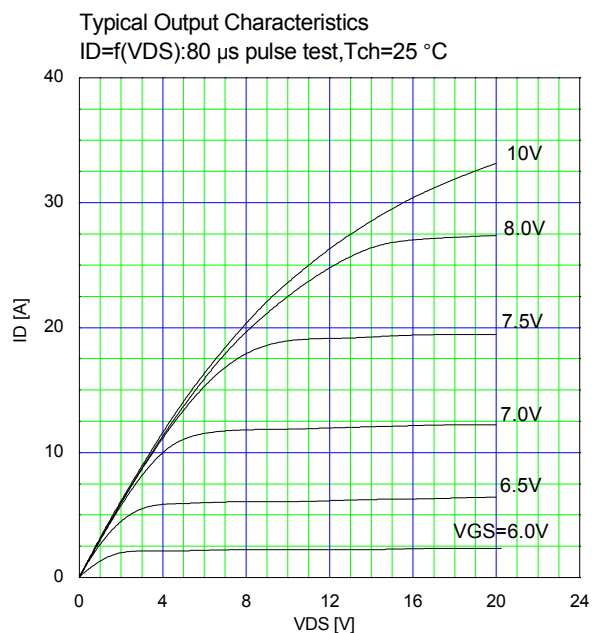
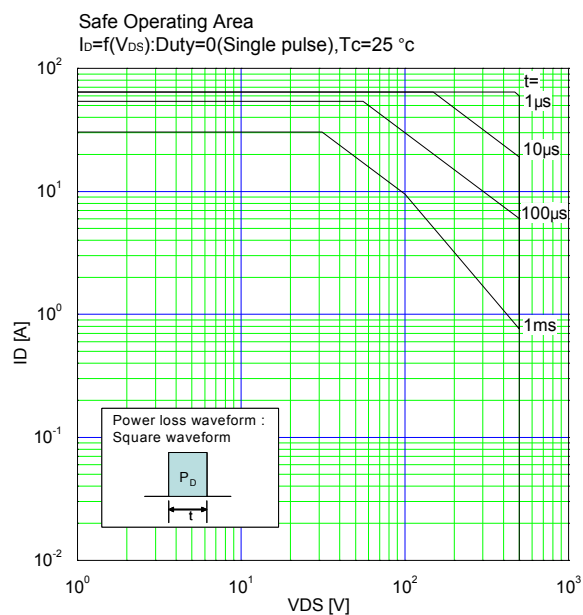
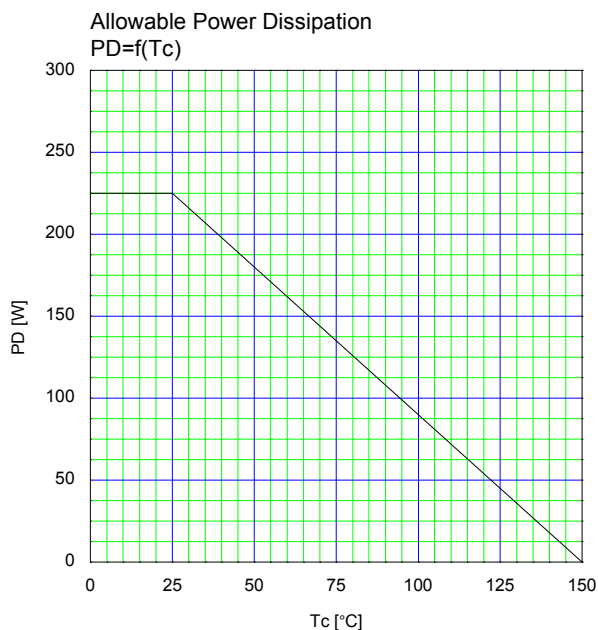
See to 'Avalanche Energy' graph.

Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature.

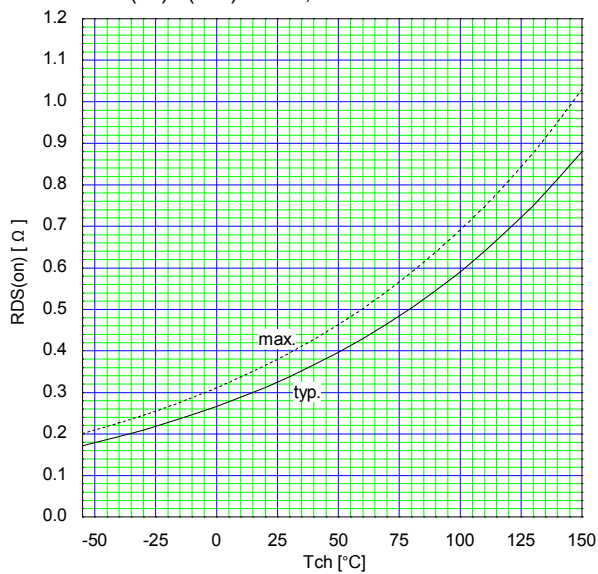
See to the 'Transient Thermal impedance' graph.

Note *4 : $I_{FS}=ID$, $-di/dt=100A/\mu\text{s}$, $V_{cc}=BV_{DSS}$, $T_{ch} \leq 150^\circ\text{C}$.

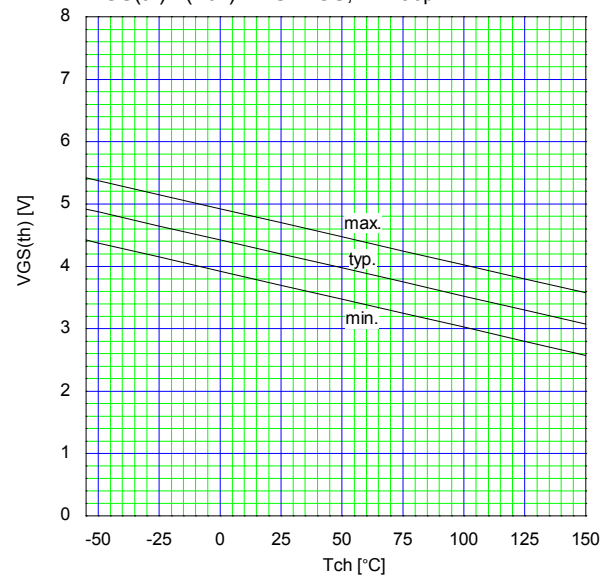
Note *5 : $I_{FS}=ID$, $dv/dt=4.8kV/\mu\text{s}$, $V_{cc}=BV_{DSS}$, $T_{ch} \leq 150^\circ\text{C}$.



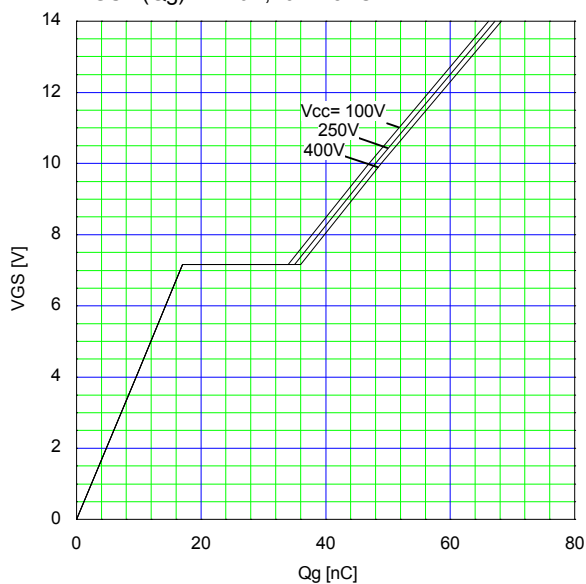
Drain-Source On-state Resistance
 $R_{DS(on)} = f(T_{ch}): I_D = 8A, V_{GS} = 10V$



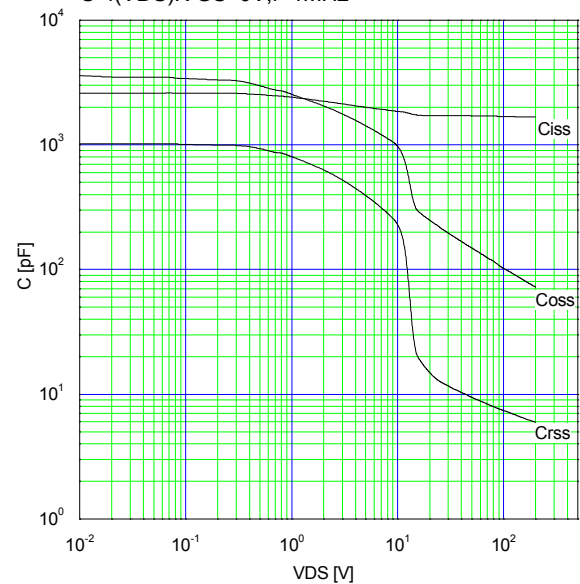
Gate Threshold Voltage vs. T_{ch}
 $V_{GS(th)} = f(T_{ch}): V_{DS} = V_{GS}, I_D = 250\mu A$



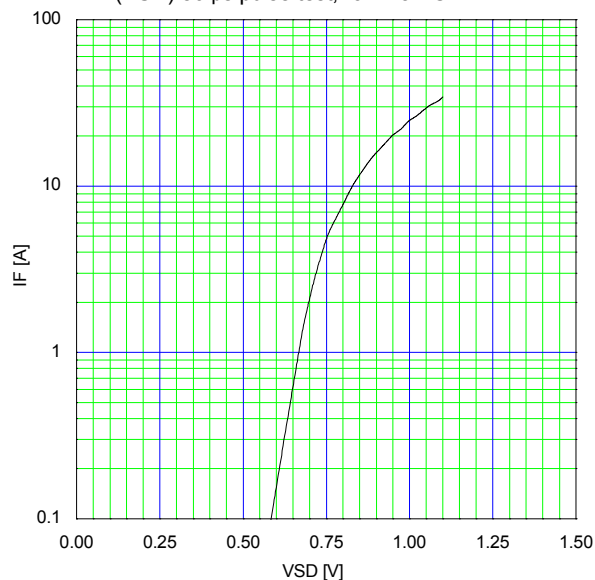
Typical Gate Charge Characteristics
 $V_{GS} = f(Q_g): I_D = 16A, T_{ch} = 25^{\circ}C$



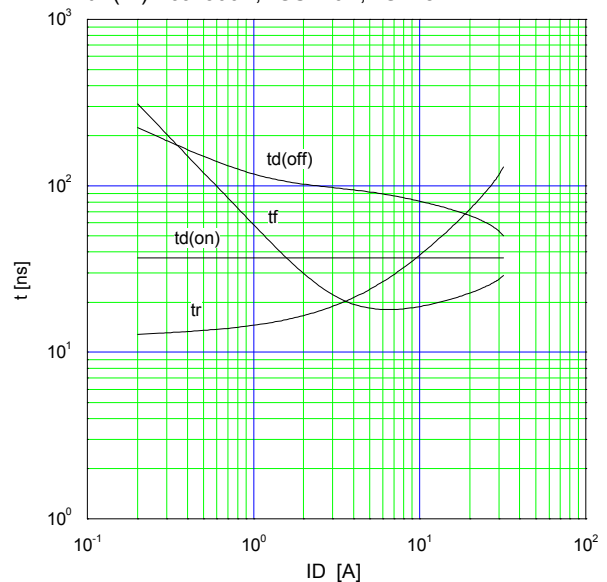
Typical Capacitance
 $C = f(V_{DS}): V_{GS} = 0V, f = 1MHz$

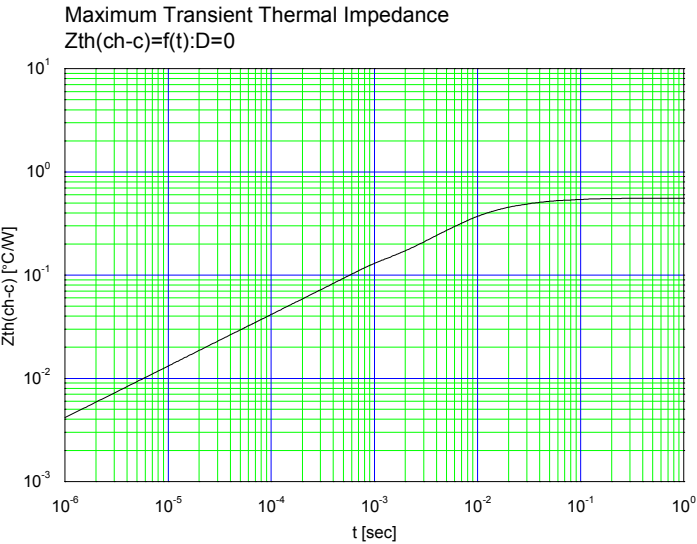
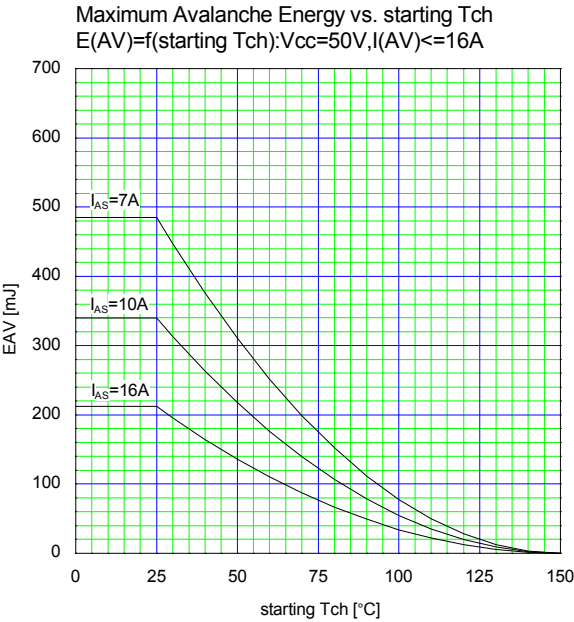


Typical Forward Characteristics of Reverse Diode
 $I_F = f(V_{SD}): 80\mu s$ pulse test, $T_{ch} = 25^{\circ}C$



Typical Switching Characteristics vs. I_D
 $t = f(I_D): V_{CC} = 300V, V_{GS} = 10V, R_G = 18\Omega$





WARNING

1. This Catalog contains the product specifications, characteristics, data, materials, and structures as of September 2015.
The contents are subject to change without notice for specification changes or other reasons. When using a product listed in this Catalog, be sure to obtain the latest specifications.
2. All applications described in this Catalog exemplify the use of Fuji's products for your reference only. No right or license, either express or implied, under any patent, copyright, trade secret or other intellectual property right owned by Fuji Electric Co., Ltd. is (or shall be deemed) granted. Fuji Electric Co., Ltd. makes no representation or warranty, whether express or implied, relating to the infringement or alleged infringement of other's intellectual property rights which may arise from the use of the applications described herein.
3. Although Fuji Electric Co., Ltd. is enhancing product quality and reliability, a small percentage of semiconductor products may become faulty. When using Fuji Electric semiconductor products in your equipment, you are requested to take adequate safety measures to prevent the equipment from causing a physical injury, fire, or other problem if any of the products become faulty. It is recommended to make your design failsafe, flame retardant, and free of malfunction.
4. The products introduced in this Catalog are intended for use in the following electronic and electrical equipment which has normal reliability requirements.

• Computers	• OA equipment	• Communications equipment (terminal devices)	• Measurement equipment
• Machine tools	• Audiovisual equipment	• Electrical home appliances	• Personal equipment
			• Industrial robots etc.
5. If you need to use a product in this Catalog for equipment requiring higher reliability than normal, such as for the equipment listed below, it is imperative to contact Fuji Electric Co., Ltd. to obtain prior approval. When using these products for such equipment, take adequate measures such as a backup system to prevent the equipment from malfunctioning even if a Fuji's product incorporated in the equipment becomes faulty.

• Transportation equipment (mounted on cars and ships)	• Trunk communications equipment
• Traffic-signal control equipment	• Gas leakage detectors with an auto-shut-off feature
• Emergency equipment for responding to disasters and anti-burglary devices	• Safety devices
• Medical equipment	
6. Do not use products in this Catalog for the equipment requiring strict reliability such as the following and equivalents to strategic equipment (without limitation).

• Space equipment	• Aeronautic equipment	• Nuclear control equipment
• Submarine repeater equipment		
7. Copyright ©1996-2015 by Fuji Electric Co., Ltd. All rights reserved.
No part of this Catalog may be reproduced in any form or by any means without the express permission of Fuji Electric Co., Ltd.
8. If you have any question about any portion in this Catalog, ask Fuji Electric Co., Ltd. or its sales agents before using the product.
Neither Fuji Electric Co., Ltd. nor its agents shall be liable for any injury caused by any use of the products not in accordance with instructions set forth herein.